SL-T3216PTB020-L233

DATA SHEET

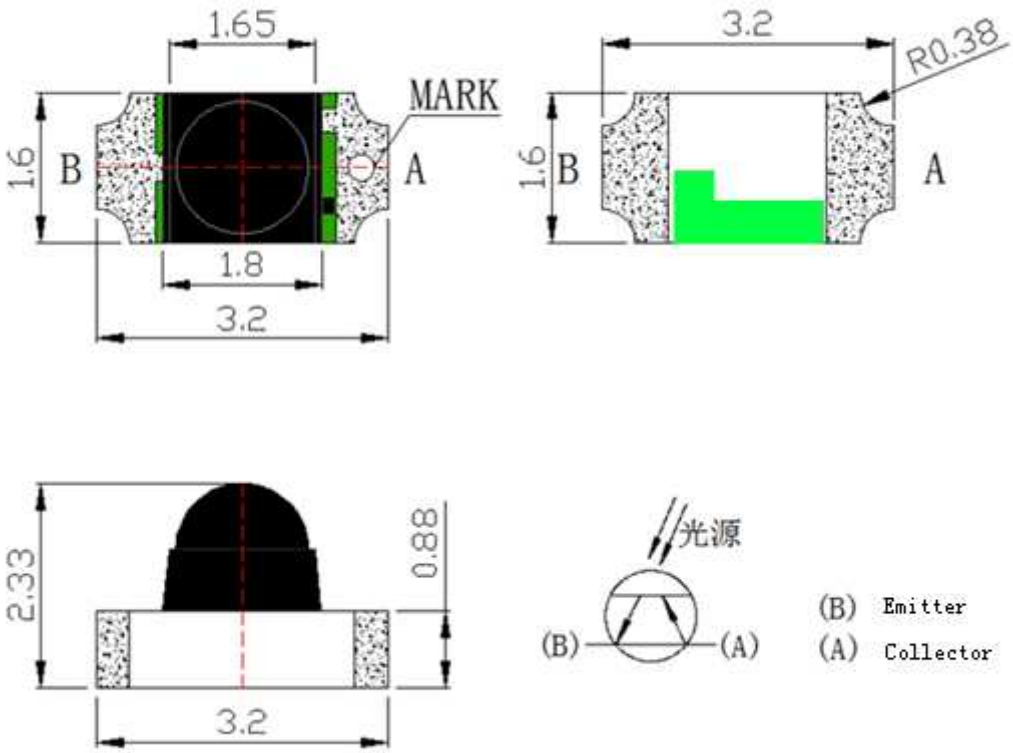
SPEC. NO. : SZ20060504
DATE : 2020/06/05
REV. : A/0

Approved By: Checked By: Prepared By:

Features

- Pb free product—RoHS compliant
- Low power consumption, High efficiency
- Reliable and rugged
- Long life – solid state reliability
- Fast response time
- High photo sensitivity

Package Dimension



Part NO.	Chip Material	Lens Color
SL-T3216PTB020-L233	Silicon	Black

Notes:

1. All dimensions are in millimeters.
2. Tolerance is ±0.10mm unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings at Ta=25℃

Parameter	MAX.	Unit
Power Dissipation	100	mW
Collector-Emitter Voltage	30	V
Emitter-Collector Voltage	5	V
Collector Current	20	mA
Electrostatic Discharge (HBM)*2	2000	V
Moisture Sensitivity Level*1	4	
Operating Temperature	-40℃ to + 85℃	
Storage Temperature	-40℃ to + 100℃	
Reflow Condition	260℃ MAX for 10 Seconds	

1. **Storage and operating:**

(1). Storage requirements before vacuum bag opened: Temperature<30℃, Humidity<65%RH;

(2). Check air leakage and vacuum bag damage before opened. If there is any issue found, check the humidity indicator card immediately after bag opened:

a. If color changes on "10% circle" of the humidity indicator card only and not the circles of 20% and above, components can be used without additional handling;

b. If color changes on both 10% and 20% circles but not the circles of 30% and above, components must be dehumidified according to the conditions of bullet (5);

c. If color changes on 10%, 20%, and 30% circle or above, the product should be returned to the supplier for high temperature dehumidification;

(3). After bag opened, manual soldering or reflow process must follow the following requirements:

a. Complete soldering / reflow within 72 hours;

b. Requirements of working environment: Temperature<30℃, Humidity<60%RH;

(4). If the working condition is outside (3)a requirement, the components must be dehumidified according to the conditions of bullet (5);

(5). Low temperature dehumidification: temperature 60-65℃, at least 24 hours;

(6). Shelf life: 180 days. If it's over 180 days from the production date on the package label, the components must be dehumidified according to the condition of bullet (5). If customer is unable to dehumidify, return components to LIGHT for dehumidification.

2. **Caution in ESD:**

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Electrical Optical Characteristics at Ta=25℃

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Range Of Spectral Bandwidth	$\lambda_{0.5}$	780	---	1100	nm	---
Wavelength Of Peak Sensitivity	λ_P	---	940	---	nm	---
Collector-Emitter Breakdown Voltage	BV_{CEO}	30	---	---	V	I_C=0.1mA Ee=0mW/cm2
Emitter-Collector Breakdown Voltage	BV_{ECO}	5	---	---	V	I_E=0.1mA Ee=0mW/cm2
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	---	---	0.4	V	I_C=0.1mA Ee=1mW/cm2
Rise Time	Tr	---	15	---	μs	V_{CE}=5V I_C=1mA R_L=1000Ω
Fall Time	Tf	---	15	---	μs	
Viewing Angle	$2\theta_{1/2}$	---	50	---	Deg.	---
Collector Dark Current	I_{CEO}	---	---	100	nA	V_{CE}=10V Ee=0mW/cm2
On State Collector Current	$I_{C(ON)}$	1.0	---	---	mA	V_{CE}=5V Ee=1mW/cm2 λp=940nm

Note:

1. $\theta_{1/2}$ is the off-axis angle at which the $I_{C(ON)}$ is half the axial $I_{C(ON)}$.
2. The $I_{C(ON)}$ guarantee should be added ±15% tolerance.

Typical Electrical / Optical Characteristics Curves
(25℃ Ambient Temperature Unless Otherwise Noted)

FIG.1 Relative Response vs. Wavelength

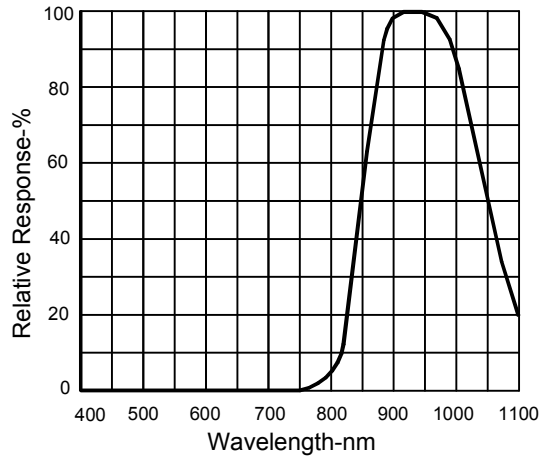


FIG.2 Power Dissipation Vs. Ambient Temperature

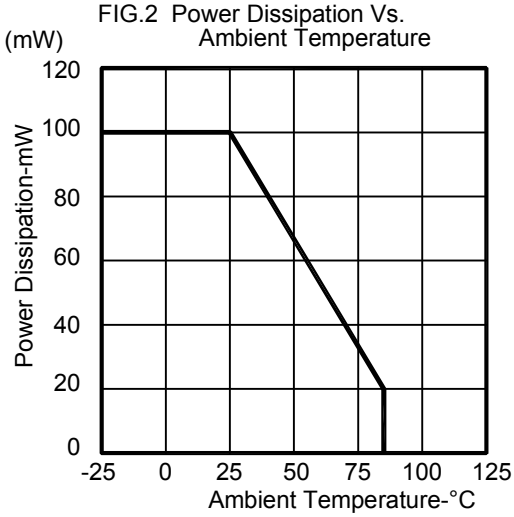


FIG.3 Rise And Fall Time Vs. Load Resistance

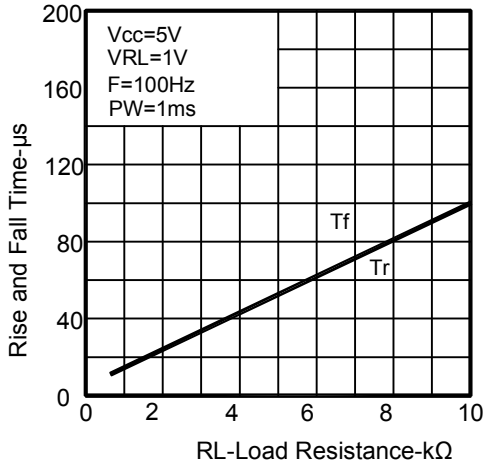


FIG.4 Relative Collector Current Vs. Irradiance

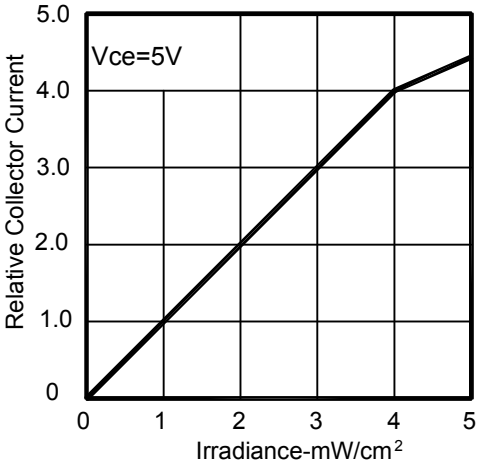


FIG.5 Collector Dark Current Vs. Ambient Temperature

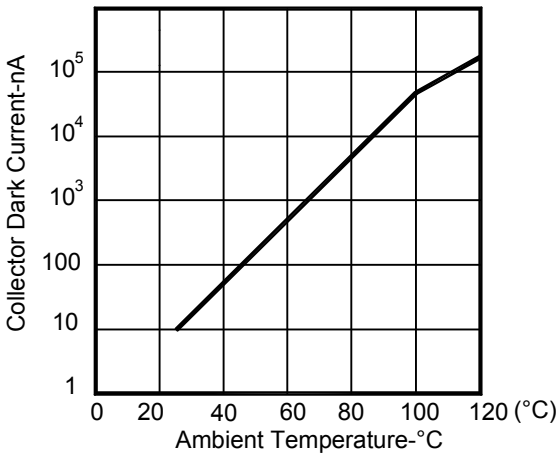
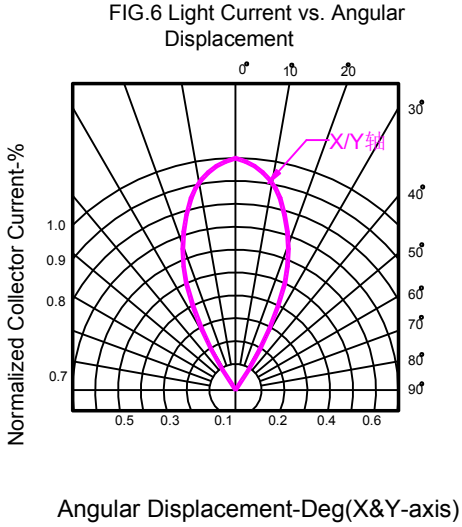
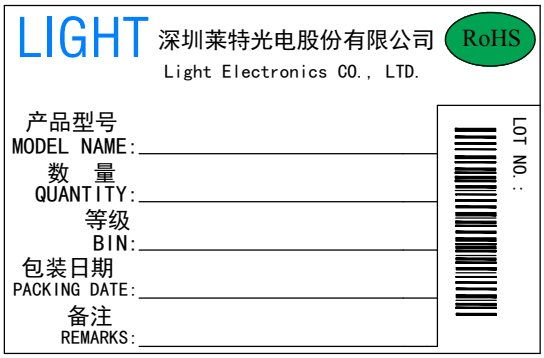


FIG.6 Light Current vs. Angular Displacement

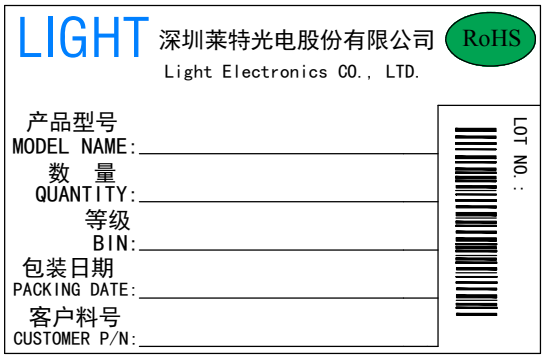


Label Explanation

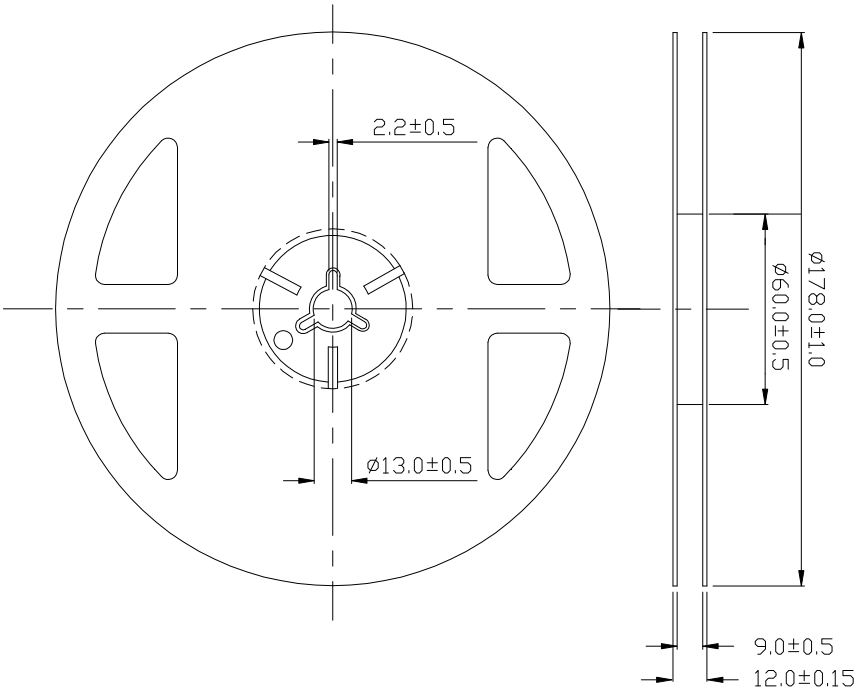
LIGHT Universal Label
(Reel Label)



Customer Defined Label
(Aluminum Moisture Proof Bag Label)

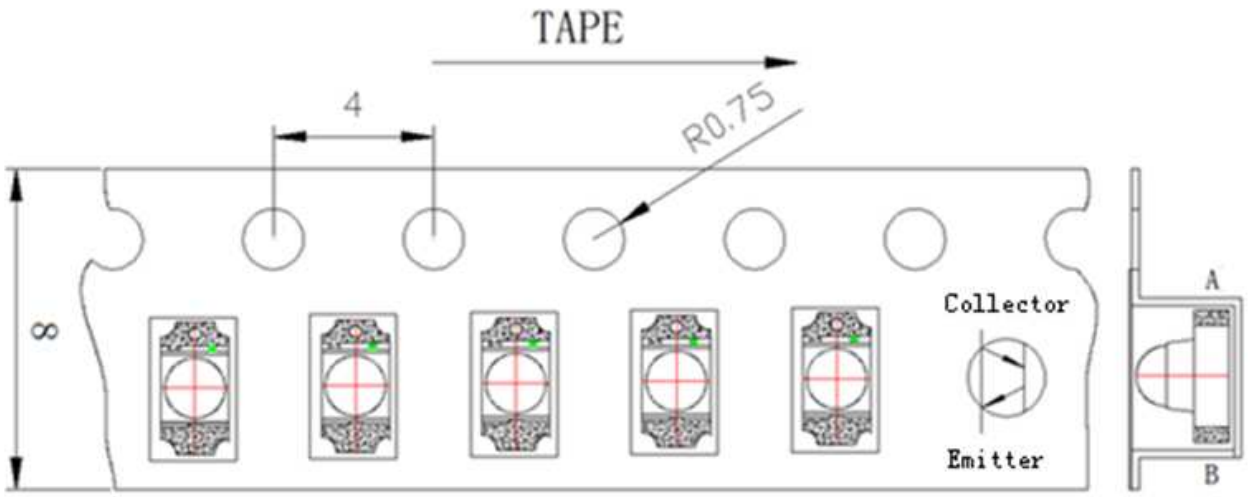


Reel Dimensions



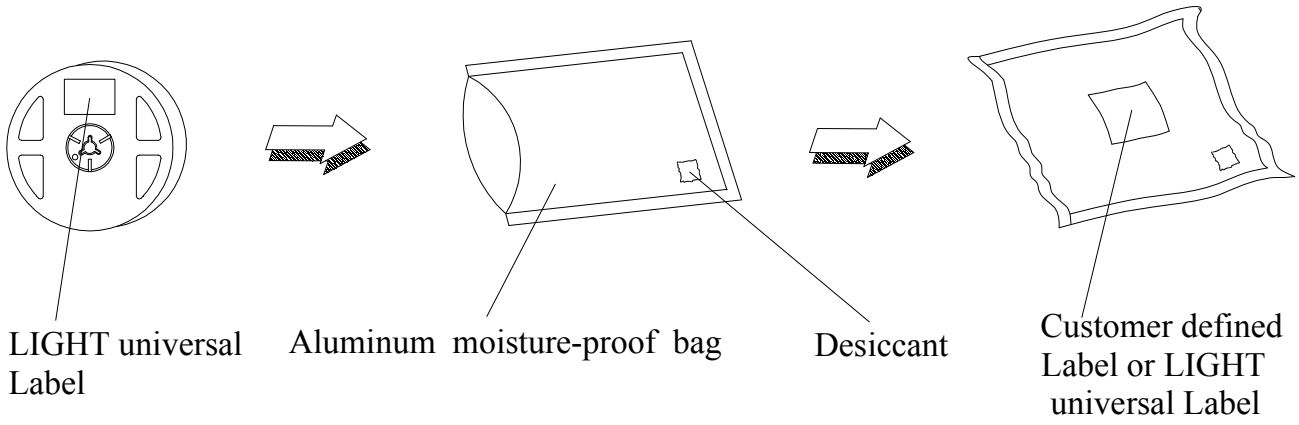
Note: Tolerance unless mentioned is ±0.2mm; Unit = mm

Carrier Tape Specifications

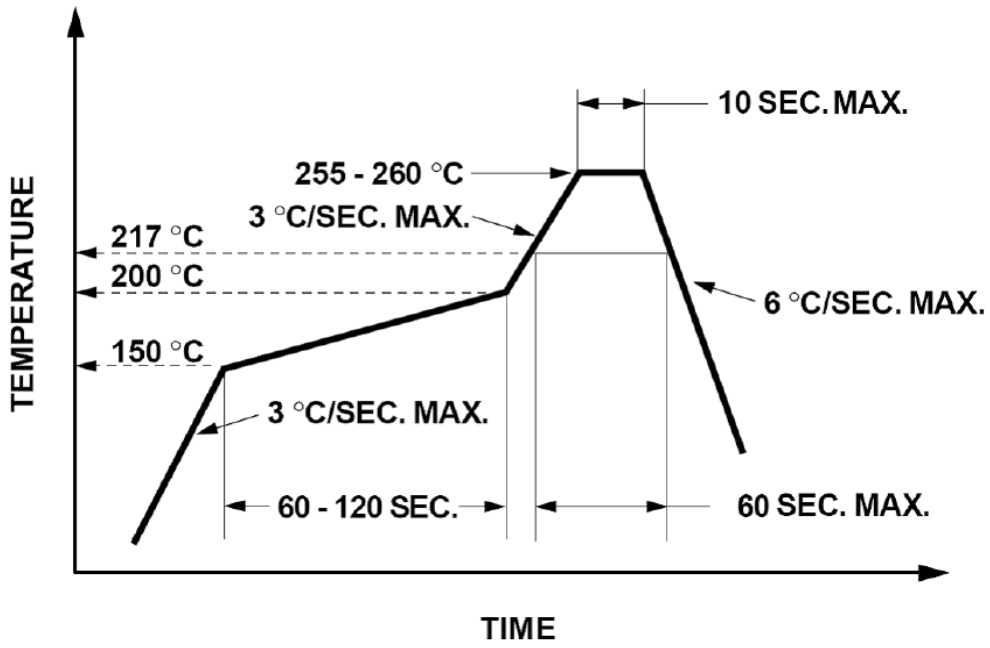


Note: Tolerance unless mentioned is ±0.1mm; Unit = mm

Moisture Resistant Packaging



Suggest IR Reflow Condition For Lead Free



1. Reflow soldering should not be done more than two times.
2. When soldering, do not put stress on the LEDs during heating.

Soldering iron

1. When hand soldering, the temperature of the iron must less than 300℃ for 3 seconds.
2. The hand solder should be done only once.

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.